IPC ASSOCIATION CONNECTINE ELECTRONICS INDUSTRIE	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute					* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Inforn	nation														
Company name*			Company unique ID			τ	Unique ID Authority				Respon	Response Date*			
onsemi											2024-04	2024-04-23			
Contact Name			Title - Contact			1	Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Represe	entative*		Title - Representative			1	Phone - Representative*				Email - Representative*				
Product-Env-Stewa	ards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requesto	Requester Item Number Mfr I		tem Number Mfr Item Name				Effective Date	Versio	on	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP3031 G	NCP303151AMNTW 50A IMON Power Stag		r Stage DRMO	OS	2024-04-23			MY5		86.5633	mg	Each	
<b>Ianufacturing</b>	Proccess Information	on													
Terminal Plating / Grid Array Material Term			rminal Base Alloy J-STD-020 MSI			SL Rating	Peak Process Body Temperature Max Time at Peak				k Tempera	ture Numb	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed		C	CU Alloy 1		1		260 C 30		30	secor	nds 3				
omments															
vel 1 - maximum t	ime at peak temperature	during sol	dering is 10-3	0 seconds											
or more informati	on regarding material co	mposition [	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.8004	mg	Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Iron (Fe)	7439-89-6		0.1598	mg
			Supplier	Copper (Cu)	7440-50-8		6.6304	mg
			Supplier	Phosphorus (P)	7723-14-0		0.002	mg
Clip Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.0075	mg
			A	Lead (Pb)	7439-92-1		0.2775	mg
			Supplier	Tin (Sn)	7440-31-5		0.015	mg
Die	2.7629	mg	Supplier	Silicon (Si)	7440-21-3		2.7629	mg
Epoxy	4.401	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.3521	mg
			Supplier	Proprietary	Proprietary Data		0.3961	mg
			Supplier	Bismaleimide	13676-54-5		1.1883	mg
ı			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.044	mg
			Supplier	PTFE	9002-84-0		2.4206	mg
Lead Frame	32.9996	mg	Supplier	Zinc (Zn)	7440-66-6		0.0396	mg
			Supplier	Iron (Fe)	7439-89-6		0.7755	mg
			Supplier	Copper (Cu)	7440-50-8		32.1746	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0099	mg
Mold Compound-Black	36.0995	mg		Proprietary	proprietary data		2.888	mg
-			Supplier	Carbon Black (C)	1333-86-4		0.1805	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		33.031	mg
Plating	2.9998	mg	Supplier	Tin (Sn)	7440-31-5		2.9998	mg
Wire Bond - Cu	0.2001	mg	Supplier	Palladium (Pd)	7440-05-3		0.0036	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
			Supplier	Copper (Cu)	7440-50-8		0.1963	mg